

L Number	Hits	Search Text	DB	Time stamp
-	617	(118/718).CCLS.	USPAT; US-PGPUB	2003/05/05 07:47
-	1	09/812,075	USPAT; US-PGPUB	2003/05/04 20:54
-	0	20020002945.URPN.	USPAT	2003/05/04 21:02
-	1	("5364481").PN.	USPAT; US-PGPUB	2003/05/04 21:16
-	138	((118/718).CCLS.) and cut\$4	USPAT; US-PGPUB	2003/05/09 11:00
-	225	((118/718).CCLS.) and rotat\$4	USPAT; US-PGPUB	2003/05/04 21:50
-	55	((118/718).CCLS.) and (rotat\$4 with (open\$3 clos\$3 seal))	USPAT; US-PGPUB	2003/05/04 22:25
-	5	5364481.URPN.	USPAT	2003/05/04 22:03
-	5	5364481.URPN.	USPAT	2003/05/04 22:04
-	5	5364481.URPN.	USPAT	2003/05/04 22:04
-	49	(118/\$.ccls. 156/345.\$ccls.) and (rotat\$4 with triang\$4)	USPAT; US-PGPUB	2003/05/04 22:43
-	2398	((118/314) or (118/315) or (118/324) or (118/325) or (156/345.2) or (156/345.22) or (156/345.31)).CCLS.	USPAT; US-PGPUB	2003/05/04 22:44
-	1	((118/314) or (118/315) or (118/324) or (118/325) or (156/345.2) or (156/345.22) or (156/345.31)).CCLS.) and (rotat\$4 with triang\$4)	USPAT; US-PGPUB	2003/05/04 22:45
-	2	c23c016\$.ipc. and (rotat\$4 with triang\$4)	EPO; JPO; DERWENT	2003/05/04 22:45
-	332	(118/227).CCLS.	USPAT; US-PGPUB	2003/05/05 09:09
-	559	((118/227) or (118/224)).CCLS.	USPAT; US-PGPUB	2003/05/05 07:58
-	1041	(118/323).CCLS.	USPAT; US-PGPUB	2003/05/05 07:58
-	462	((118/323).CCLS.) and (rotat\$4)	USPAT; US-PGPUB	2003/05/05 07:59
-	7	5429676.URPN.	USPAT	2003/05/05 08:40
-	1	5672376.URPN.	USPAT	2003/05/05 08:52
-	2	("3448717" "5040729").PN.	USPAT	2003/05/05 09:03
-	0	6358320.URPN.	USPAT	2003/05/05 09:04
-	45	(118/311).CCLS.	USPAT; US-PGPUB	2003/05/05 09:17
-	3	2000077.URPN.	USPAT	2003/05/05 09:16
-	320	(118/309).CCLS.	USPAT; US-PGPUB	2003/05/05 09:17
-	1	2572743.URPN.	USPAT	2003/05/05 09:23
-	1	5861062.URPN.	USPAT	2003/05/05 09:35
-	62	(156/345.22).CCLS.	USPAT; US-PGPUB	2003/05/05 09:54
-	160	(156/345.33).CCLS.	USPAT; US-PGPUB	2003/05/05 09:54
-	126	(156/345.34).CCLS.	USPAT; US-PGPUB	2003/05/05 09:54
-	0	("441 442").PN.	USPAT; US-PGPUB	2003/05/05 09:54
-	38	(156/345.2).CCLS.	USPAT; US-PGPUB	2003/05/05 09:54
-	267	((156/345.33).CCLS.) ((156/345.34).CCLS.)	USPAT; US-PGPUB	2003/05/05 10:26
-	1	("2157944").PN.	USPAT; US-PGPUB	2003/05/05 10:01
-	3	2157944.URPN.	USPAT	2003/05/05 10:01
-	74	118/715.ccls. and triang\$4	USPAT; US-PGPUB	2003/05/05 10:26
-	22	((156/345.33).CCLS.) ((156/345.34).CCLS.) and triang\$4	USPAT; US-PGPUB	2003/05/05 10:37
-	2	118/\$.ccls. and (filament with cane)	USPAT; US-PGPUB	2003/05/05 10:45
-	31	((156/345.33).CCLS.) ((156/345.34).CCLS.) and conic\$3	USPAT; US-PGPUB	2003/05/05 10:40
-	656	118/\$.ccls. and ((chamber enclosure apparatus) with (triang\$4 conical\$4))	USPAT; US-PGPUB	2003/05/06 14:43

-	40	118/\$.ccls. and (heat\$3 with filament with (support mount))	USPAT;	2003/05/05 13:34
-	29	filament with cane	US-PGPUB	2003/05/05 10:48
-	21	filament with cane	USPAT;	2003/05/05 10:48
-	85	156/345\$.ccls. and ((chamber enclosure apparatus) with (triang\$4 conical\$4))	US-PGPUB	2003/05/05 11:02
-	36	156/345\$.ccls. and ((cross\$1section) with (triang\$4 conical\$4))	USPAT;	2003/05/05 11:05
-	6	c23c016\$.ipc. and ((cross\$1section) with (triang\$4 conical\$4))	US-PGPUB	2003/05/05 11:10
-	1	("4993360").PN.	EPO; JPO;	2003/05/05 11:07
-	0	h011021.ipc. and ((cross\$1section) with (triang\$4 conical\$4))	DERWENT	2003/05/05 11:11
-	30	(chamber apparatus enclosure) and ((cross\$1section) with (triang\$4 conical\$4)) and (wafer semiconductor substrate)	USPAT;	2003/05/05 11:11
-	27	118/\$.ccls. and (chamber adj (triang\$4 conical\$4))	EPO; JPO;	2003/05/05 15:56
-	1	118/\$.ccls. and (vacuum with conduit with (detach\$4))	US-PGPUB	2003/05/05 12:00
-	2	156/345\$.ccls. and (heat\$3 with filament with (support mount))	USPAT;	2003/05/05 13:35
-	21	156/345\$.ccls. and (heat\$3 with coil with (support mount))	US-PGPUB	2003/05/05 13:37
-	407	(heat\$3 with (coil filament) with (support\$3 mount\$3) with (detach\$4 remov\$4))	USPAT;	2003/05/05 14:38
-	65	(heat\$3 with (coil filament) with (support mount) with (detach\$4 remov\$4))	US-PGPUB	2003/05/05 14:43
-	0	60-161619	DERWENT	2003/05/05 13:55
-	2	"60161619"	EPO; JPO;	2003/05/05 13:55
-	11	(heat\$3 with (coil filament) with (support\$3 mount\$3) with (detach\$4 remov\$4) with clean\$3)	DERWENT	2003/05/05 14:43
-	446	(heat\$3 with (support\$3 mount\$3) with (detach\$4 remov\$4) with clean\$3)	USPAT;	2003/05/05 14:48
-	118	(heat\$3 with (coil filament) with (detach\$4 remov\$4) with clean\$3)	US-PGPUB	2003/05/05 14:43
-	9	c23c016\$.ipc. and (heat\$3 with (coil filament) with (detach\$4 remov\$4))	USPAT;	2003/05/05 14:46
-	109	(wafer substrate semiconductor) and (heat\$3 with (coil filament) with (detach\$4 remov\$4))	EPO; JPO;	2003/05/05 14:47
-	0	118/724\$.ccls. and (heat\$3 with (support\$3 mount\$3) with (detach\$4 remov\$4) with clean\$3)	DERWENT	2003/05/05 14:49
-	5	118/724.ccls. and (heat\$3 with (support\$3 mount\$3) with (detach\$4 remov\$4) with clean\$3)	USPAT;	2003/05/05 14:50
-	1	118/724.ccls. and (heat\$3 with (support\$3 mount\$3) with (detach\$4 remov\$4) with (coil filament))	US-PGPUB	2003/05/05 14:50
-	61	118/724.ccls. and (heat\$3 with (support\$3 mount\$3) with (detach\$4 remov\$4))	USPAT;	2003/05/05 14:53
-	1	118/724.ccls. and ((filament coil) with heat\$3 with (support\$3 mount\$3) with (detach\$4 remov\$4))	US-PGPUB	2003/05/05 14:54
-	3	118/724.ccls. and ((filament coil) with (support\$3 mount\$3) with (detach\$4 remov\$4))	USPAT;	2003/05/05 14:54
-	1	("5053252").PN.	US-PGPUB	2003/05/05 15:37
-	337	118/\$.ccls. and (vacuum with (mov\$4 detach\$4 remov\$4) with (conduit pipe line))	USPAT;	2003/05/05 16:13

-	216	118/\$.ccls. and (vacuum with (detach\$4 remov\$4) with (conduit pipe line))	USPAT;	2003/05/05 16:14
-	111	118/715-733.ccls. and (vacuum with (detach\$4 remov\$4) with (conduit pipe line))	US-PGPUB USPAT;	2003/05/05 16:21
-	37	c23c016\$.ipc. and (vacuum with (detach\$4 remov\$4) with (conduit pipe line))	EPO; JPO;	2003/05/05 16:21
-	0	c23c016\$.ipc. and (vacuum with (disconnect\$4) with (conduit pipe line))	DERWENT EPO; JPO;	2003/05/05 16:33
-	17	118/715-733.ccls. and (vacuum with (detach\$4 disconnect\$3) with (conduit pipe line))	DERWENT USPAT;	2003/05/05 16:22
-	17	c23c016\$.ipc. and (vacuum with (connect\$4) with (conduit pipe line) with (plural\$3 multipl\$3))	US-PGPUB EPO; JPO;	2003/05/05 16:39
-	0	c23c016\$.ipc. and (vacuum with (disconnect\$4) with (conduit pipe line) with (plural\$3 multipl\$3))	DERWENT EPO; JPO;	2003/05/05 16:37
-	28	c23c016\$.ipc. and (vacuum with (mov\$4) with (source))	DERWENT EPO; JPO;	2003/05/05 16:39
-	1073	(118/726).CCLS.	USPAT;	2003/05/06 10:30
-	131	((118/726).CCLS.) and filament	US-PGPUB USPAT;	2003/05/06 10:31
-	291	((118/726).CCLS.) and (filament coil)	US-PGPUB USPAT;	2003/05/06 10:48
-	0	((118/726).CCLS.) and thermoform\$3	US-PGPUB USPAT;	2003/05/06 14:25
-	1248	(118/719).CCLS.	US-PGPUB USPAT;	2003/05/06 14:28
-	0	((118/719).CCLS.) and thermoform\$3	US-PGPUB USPAT;	2003/05/06 14:28
-	1	("5811050").PN.	US-PGPUB USPAT;	2003/05/06 14:30
-	0	9/788,263	US-PGPUB USPAT;	2003/05/06 14:30
-	1	09/785,975	US-PGPUB USPAT;	2003/05/06 14:31
-	2	09/788,263	US-PGPUB USPAT;	2003/05/06 14:31
-	4	thermoform\$3 same (metallizing metallising) same (chamber apparatus)	US-PGPUB USPAT;	2003/05/06 14:40
-	5	5811050.URPN.	US-PGPUB USPAT;	2003/05/06 14:36
-	7	"27610"	EPO; JPO;	2003/05/06 14:41
-	165	118/\$.ccls. and ((chamber enclosure apparatus) with (triang\$4))	DERWENT USPAT;	2003/05/06 15:21
-	5	5364481.URPN.	US-PGPUB USPAT	2003/05/06 14:55
-	1	"5108540".PN.	USPAT	2003/05/06 15:06
-	2	6291800.URPN.	USPAT	2003/05/06 15:07
-	1	"5525159".PN.	USPAT	2003/05/06 15:15
-	1	6357385.URPN.	USPAT	2003/05/06 15:15
-	12299	118/\$.ccls. and (rotat\$3)	USPAT;	2003/05/06 15:22
-	681	118/715.ccls. and (rotat\$3)	US-PGPUB USPAT;	2003/05/06 15:22
-	627	118/719.ccls. and (rotat\$3)	US-PGPUB USPAT;	2003/05/06 15:30
-	245	118/719.ccls. and (rotat\$3 with (surface face side))	US-PGPUB USPAT;	2003/05/06 15:33
-	273	118/715.ccls. and (rotat\$3 with (surface face side))	US-PGPUB USPAT;	2003/05/06 15:32
-	484	((118/719.ccls. and (rotat\$3 with (surface face side))) (118/715.ccls. and (rotat\$3 with (surface face side))))	US-PGPUB USPAT;	2003/05/06 15:34
-	169	(metal with (coat\$3 deposit\$3)) same shap\$3 same cut\$4 same (apparatus chamber convey\$3 station)	US-PGPUB USPAT;	2003/05/08 12:11
-	169	(metal with (coat\$3 deposit\$3)) same shap\$3 same cut\$4 same (apparatus chamber convey\$3 station)	US-PGPUB USPAT;	2003/05/08 12:14

-	38	(metal with (coat\$3 deposit\$3)) same shap\$3 same cut\$4 same (apparatus chamber convey\$3 station)	EPO; JPO; DERWENT	2003/05/08 14:58
-	1	("4201837").PN.	USPAT;	2003/05/08 18:02
-	1	("5503941").PN.	US-PGPUB	2003/05/08 18:02
-	16	118/\$.ccls. and ((conic\$ trianl\$) with (out outward) with direct\$3)	USPAT;	2003/05/09 10:59
-	80	((conic\$ trianl\$) with (out outward) with direct\$3) with chamber	US-PGPUB	2003/05/08 20:26
-	52	c23c016\$.ipc. and ((conic\$ trianl\$) with (chamber apparatus))	EPO; JPO; DERWENT	2003/05/08 20:27
-	18	118/\$.ccls. and ((conic\$ trianl\$) with (chamber apparatus))	EPO; JPO; DERWENT	2003/05/08 20:44
-	546	118/\$.ccls. and ((conic\$ trianl\$) with (chamber apparatus))	USPAT;	2003/05/08 20:49
-	1	("4161356").PN.	US-PGPUB	2003/05/08 20:45
-	25	4161356.URPN.	USPAT	2003/05/08 20:46
-	137	118/\$.ccls. and ((conic\$ trianl\$) with (chamber apparatus) with (flow\$3 direct\$3))	USPAT; US-PGPUB	2003/05/08 20:50